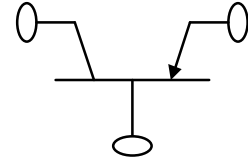


DIE SPECIFICATION

SWITCHING TRANSISTOR PNP SILICON

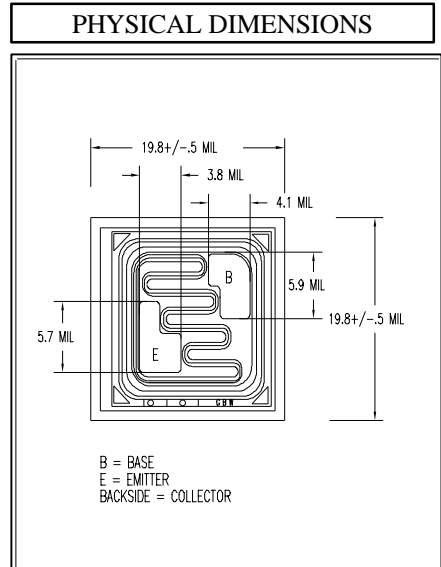


FEATURES:

- ELECTRICAL PERFORMANCE I.A.W. MIL-PRF-19500/291
- AVAILABLE IN WAFER OR CHIP FORM FOR HYBRID APPLICATIONS
- GENERAL PURPOSE-HIGH SPEED SWITCHING APPLICATIONS
- LOW $V_{CE(sat)}$: .4V @ $I_C = 150 \text{ mAdc}$

Absolute Maximum Ratings:

Symbol	Parameter	Limit	Unit
V_{ce}	Collector-Emitter Voltage	60	Vdc
V_{cb}	Collector-Base Voltage	60	Vdc
V_{eb}	Emitter-Base Voltage	5.0	Vdc
I_c	Collector Current- Continuous	600	mAdc
T_j, T_{stg}	Operating Junction & Storage Temperature Range	-65 to +200	°C



Packaging Options:
 W: Wafer (100% probed) U: Wafer (sample probed)
 D: Chip (Waffle Pack) B: Chip (Vial)
 V: Chip (Waffle Pack, 100% visually inspected) X: Other

Processing Options:
 Standard: Capable of JANTXV applications (No Suffix)
 Suffix C: Commercial
 Suffix S: Capable of S-Level equivalent applications

Metallization Options:
 Standard: Al Top / Au Backside (No Dash #)
 Dash 1: Al Top / TiPdAg Backside

ORDERING INFORMATION:
 PART #: 2N2907A__ - __
 First Suffix Letter: Packaging Option
 Second Suffix Letter: Processing Option
 Dash #: Metallization Option

Electrical Characteristics @ $T_j = 25\text{ }^\circ\text{C}$

Symbol	Parameter	Conditions	Min	Max	Unit
OFF CHARACTERISTICS					
V(BR)CBO	Breakdown Voltage, Collector to Base	Bias Cond. D, $I_C=10\mu\text{A}$ dc	60		Vdc
V(BR)EBO	Breakdown Voltage, Emitter to Base	Bias Cond. D, $I_E=10\mu\text{A}$ dc	5		Vdc
V(BR)CEO	Breakdown Voltage, Collector to Emitter	Bias Cond. D, $I_C=10\text{mA}$ dc, pulsed	60		Vdc
ICES	Collector to Emitter Cutoff Current	Bias Cond. D, $V_{CE}=50\text{V}$ dc		50	nAdc
ICBO1	Collector to Base Cutoff Current	Bias Cond. D, $V_{CB}=50\text{V}$ dc		10	nAdc
IEBO	Emitter to Base Cutoff Current	Bias Cond. D, $V_{EB}=4\text{V}$ dc		50	nAdc
ON CHARACTERISTICS					
hFE1	Forward-Current Transfer Ratio	$V_{CE}=10\text{V}$ dc, $I_C=0.1\text{mA}$ dc	75		
hFE2	Forward-Current Transfer Ratio	$V_{CE}=10\text{V}$ dc, $I_C=1.0\text{mA}$ dc	100	450	
hFE3	Forward-Current Transfer Ratio	$V_{CE}=10\text{V}$ dc, $I_C=10\text{mA}$ dc	100		
hFE4	Forward-Current Transfer Ratio	$V_{CE}=10\text{V}$ dc, $I_C=150\text{mA}$ dc, pulsed	100	300	
hFE5	Forward-Current Transfer Ratio	$V_{CE}=10\text{V}$ dc, $I_C=500\text{mA}$ dc, pulsed	50		
VCE(sat)1	Collector to Emitter Saturation Voltage	$I_C=150\text{mA}$ dc, $I_B=15\text{mA}$ dc, pulsed		0.4	Vdc
VCE(sat)2	Collector to Emitter Saturation Voltage	$I_C=500\text{mA}$ dc, $I_B=50\text{mA}$ dc, pulsed		1.6	Vdc
VBE(sat)1	Base to Emitter Saturation Voltage	$I_C=150\text{mA}$ dc, $I_B=15\text{mA}$ dc, pulsed	0.6	1.3	Vdc
VBE(sat)2	Base to Emitter Saturation Voltage	$I_C=500\text{mA}$ dc, $I_B=50\text{mA}$ dc, pulsed		2.6	Vdc
SMALL SIGNAL CHARACTERISTICS					
hfe	Short Circuit Forward Current Xfer Ratio	$V_{CE}=10\text{V}$ dc, $I_C=1\text{mA}$ dc, $f=1\text{kHz}$	100		
/hfe/	Magnitude of Short Circuit Forward Current Transfer Ratio	$V_{CE}=20\text{V}$ dc, $I_C=50\text{mA}$ dc, $f=100\text{MHz}$	2		
Cobo	Output Capacitance	$V_{CB}=10\text{V}$ dc, $I_E=0$, $100\text{kHz} < f < 1\text{MHz}$		8	pF
Cibo	Input Capacitance	$V_{EB}=2.0\text{V}$ dc, $I_C=0$, $100\text{kHz} < f < 1\text{MHz}$		30	pF
SWITCHING CHARACTERISTICS					
ton	Saturated Turn-on Time	As defined in 19500/291 Figure 7		45	nS
toff	Saturated Turn-off Time	As defined in 19500/291 Figure 8		300	nS